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Application No. 09/768,912

IN THE CLAIMS

- 1 8. (Canceled)
- 9. (Currently amended) A semiconductor device comprising:

a single-crystal substrate made of a material different from nitride III-V compound semiconductors, said substrate extending between a first surface and a second surface opposite said first surface and having a hole extending through the substrate from said first surface to said second surface;

a device formed on one of said first and second surfaces of said single-crystal substrate using III-V compound semiconductors;

a layer disposed on one of said first and second surfaces of said single-crystal substrate, wherein said hole extends to said layer;

wherein said device is formed between said layer and said substrate and is electrically connected to said layer; and

wherein an electrical connection to said device is created via the hole extending through the substrate and contact with said layer.

- 10. (Previously presented) The semiconductor device according to claim 9, wherein said single-crystal substrate comprises a material selected from a group consisting of sapphire, spinel, perovskite yttrium aluminate, and SiC.
- 11. (Previously presented) The semiconductor device according to claim 9 wherein said semiconductor device comprises a semiconductor laser using nitride III-V compound semiconductors.
- 12. (Previously presented) The semiconductor device according to claim 9 wherein said semiconductor device comprises an FET using nitride III-V compound semiconductors.

13 - 24. (Canceled)

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25. (Currently amended) A semiconductor device comprising:

a single-crystal substrate made of a material different from nitride III-V compound semiconductors, said substrate extending between a first surface and a second surface opposite said first surface and having a hole extending through the substrate from said first surface to said second surface;

a device formed on one of said first and second surfaces of said single-crystal substrate using III-V compound semiconductors;

a layer disposed on one of said first and second surfaces of said single-crystal substrate and electrically connected to said device, said layer having a first side facing the substrate and a second side opposite the first side and facing away from the substrate, wherein said hole extends to said layer;

wherein a surface of the <u>layerdevice facing the substrate</u> is at least as close to the substrate as a <u>surface of the device the second side of the layer facing away from</u> the substrate; and

wherein an electrical connection to said device is created via the hole extending through the substrate and contact with said layer.